

:	LCD MODULE
:	LCD800WLAK-01-100C
:	LCD Mikroelektronik GmbH
:	Feb.22.2022

SPECIFICATION

Prepared by	Checked	Approved

CUSTOMER: MODEL NO.:

DATE:

Approved	Checked	Department

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Version : 1.3 Feb.22.2022

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Revision Record

Rev No.	Rev Date	Contents	Remarks
1.0	2020.12.28	New creation	
1.1	2021.02.03	Modify mechanical drawing and luminance	P5,P18
1.2	2021.07.20	Modify mechanical drawing	P5
1.3	2022.02.22	Modify mechanical drawing	P5

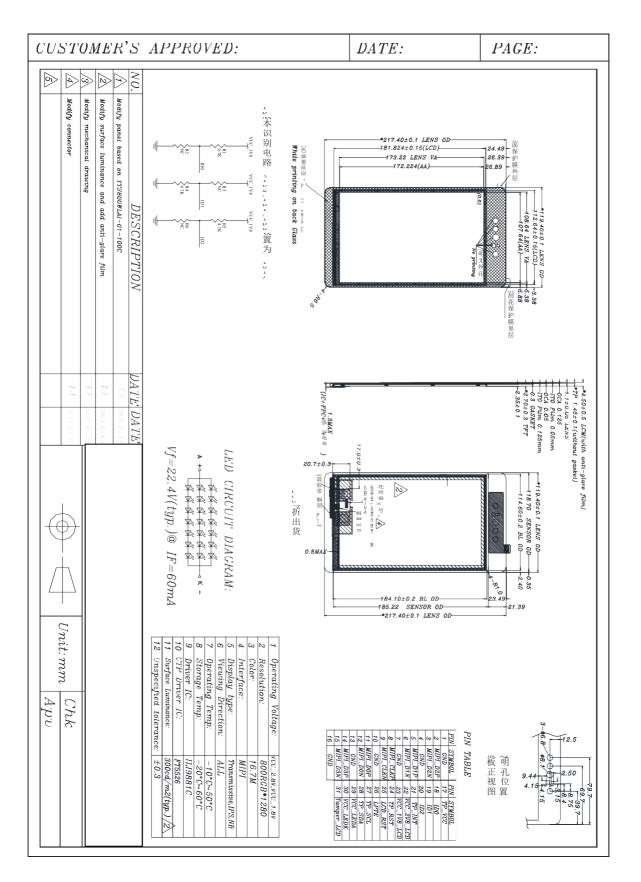
1. General Specifications

No.	Item	Contents	Unit
1	Size	8.0	inch
2	Resolution	800RGB*1280	
3	Interface	MIPI	
4	Color Depth	16.7	М
5	Technology Type	a-Si TFT	
6	Pixel Pitch	44.85*134.55	um
7	Pixel Arrangement	Pixels R.G.B Stripe arrangement	
8	Display Mode	Normally Black, Transmissive, IPS	
9	Viewing Direction	ALL	
10	LCM (W x H x D)	119.40*217.40*4.50	mm
11	Active Area (W x H)	107.64*172.224	mm
12	With/Without TSP	With CTP	
13	LED Numbers	21	

Touch Panel Parameter

No.	Features	Details	Note
1	CTP Technology	Mutual capacitor	
2	Input Method	Finger	
3	Touch point	5Point	
4	Positional Accuracy	2.5mm at 4 edges and 1.5mm at center	Unit: mm
5	Cover glass	Sodalime glass. chemically hardened	
6	Hardness	6H	
7	Surface treatment	NO	
8	Optical transmittance	87%	
9	Touch controller	FT5526	
10	Interface to Host	I2C	
11	I2C Address	0X70	
12	Connection Type	Solder Connector	

2. Mechanical Drawing





3. PIN Assignment

Pin No.	Symbol	I/O	Function	Remark
1	GND	Р	Ground.	
2	MIPI_D2P	Ι		
3	MIPID2N	Ι	MIPI DSI differential data pair. (Data lane 2)	
4	GND	Р	Ground.	
5	MIPI_D1P	I	MIDI DOI differential data nair (Data Jana 4)	
6	MIPI_D1N	Ι	MIPI DSI differential data pair. (Data lane 1)	
7	GND	Р	Ground.	
8	MIPI_CLKP	Ι	MIDI DOL differential algoly nain	
9	MIPI_CLKN	I	MIPI DSI differential clock pair	
10	GND	Р	Ground.	
11	MIPI_D0P	I	MIDI DOI differential data nair (Data Jana 0)	
12	MIPI_D0N	Ι	MIPI DSI differential data pair. (Data lane 0)	
13	GND	Р	Ground.	
14	MIPI_D3P	Ι		
15	MIPI_D3N	Ι	MIPI DSI differential data pair. (Data lane 3)	
16	GND	Р	Ground.	
17	TP_VCC	Р	TP Power supply.	
18	ID0	-	ID0.	
19	ID1	-	ID1.	
20	ID2	-	ID2.	
21	TP-INT	I	TP External interrupt to the host.	
22	VCC_2V8_LCD	Р	power supply for the analog power.	
23	VCC_1V8_LCD	Р	power supply for the logic power.	
24	TP_RST	I	TP Reset pin.	
25	LCD_RST	I	 The external reset input Initializes the chip with a low input. Be sure to execute a power-on reset after supplying power. Fix to VDDI level when not in use. 	
26	LPTE	Ι	- Tearing effect output pin. Leave the pin open when not in use.	
27	TP_SCL	I	TP Clock Signal.	
28	 TP_SDA	Ι	TP Data Signal.	
29	VCC_LEDA	Р	LED anode.	
30	VCC_LEDK	Р	LED cathode.	
31	 Tamper_LCD	-	TEST PIN.	

PS. For further details, please refer to ILI9881C data sheet.



4. Absolute Maximum Rating

AGND =	GND =	0V,Ta :	= 25 ℃
--------	-------	---------	---------------

ltem	Symbol	Min	Мах	Unit	Remark
Dower Valtage	VCC_2.8V	2.5	6.0	V	
Power Voltage	VCC_1.8V	1.75	3.3	V	
Operating Temperature	T _{OPR}	-10	50	°C	
Storage Temperature	Tstg	-20	60	°C	

Note1: The absolute maximum rating values of this product are not allowed to be exceeded at any times. Should a module be used with any of the absolute maximum ratings exceeded, the characteristics of the module may not be recovered, or in an extreme case, the module may be permanently destroyed.

5. Electrical Characteristics

5.1. Recommended Operating Condition

				AGND	= GND $=$ (0V, Ta = 25∘c
ltem	Symbol	Min	Тур.	Max	Unit	Remark
Power Voltage	VCC_2.8V	2.5	2.8	6.0	V	
	VCC_1.8V	1.75	1.8	3.3		
_	VDDI	1.65	2.8	3.3		
Input logic high voltage	Vih	0.7 VDDI	-	VDDI	V	
Input logic low voltage	Vil	-0.3	-	0.3VDDI	V	

5.2. Recommended Driving Condition for Backlight

Ta = 25∘c

	-	-	-	-	-	14 200
Item	Symbol	Min	Тур.	Max	Unit	Remark
Forward Voltage	Vf	19.6	22.4	23.8	V	
Forward Current	lf		60		mA	
Operating Life Time	-	30000			Hours	

Note 1: Ta means ambient temperature of TFT-LCD module.

Note 2: If the module is driven by high current or at high ambient temperature & humidity condition. The operating life will be reduced.

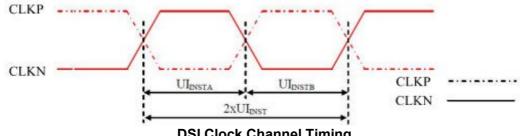
Note 3: Operating life means brightness goes down to 50% initial brightness. Minimum operating life time is estimated data.

6. Timing Characteristics

6.1. AC Electrical Characteristics

DSI Timing Characteristics

6.1.1 High Speed Mode-Clock Channel Timing



DSI Clock Channel Timing

DSI Clock Channel Timing

Signal	Symbol	Parameter	Min	Max	Unit
CLKP/N	2xUI _{INST}	Double UI instantaneous	4	25	ns
CLKP/N	UI _{INSTA} ,UI _{INSTB} (Note 1)	UI instantaneous Half	2 (Note 2)	12.5	ns

Notes:

1.UI = UIINSTA = UIINSTB

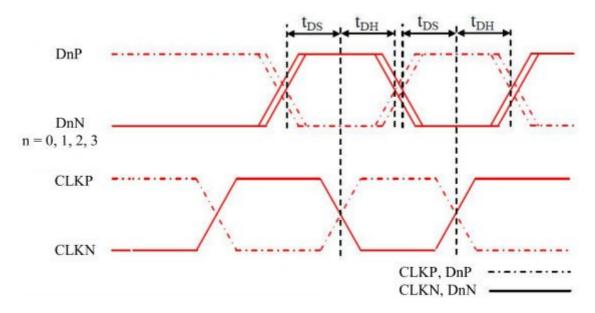
2.Define the minimum value of 24 UI per Pixel.

Limited Clock Channel Speed

Data type	Two Lanes speed	Three Lanes speed	Four Lanes speed
Data Type = 00 1110 (0Eh), RGB 565, 16 UI per Pixel	566 Mbps	433 Mbps	366 Mbps
Data Type = 01 1110 (1Eh), RGB 666, 18 UI per Pixel	637 Mbps	487 Mbps	412 Mbps
Data Type = 10 1110 (2Eh), RGB 666 Loosely, 24 UI per Pixel	850 Mbps	650 Mbps	550 Mbps
Data Type = 11 1110 (3Eh), RGB 888, 24 UI per Pixel	850 Mbps	650 Mbps	550 Mbps

6.1.2 High Speed Mode-Data Clock Channel Timing

LCD

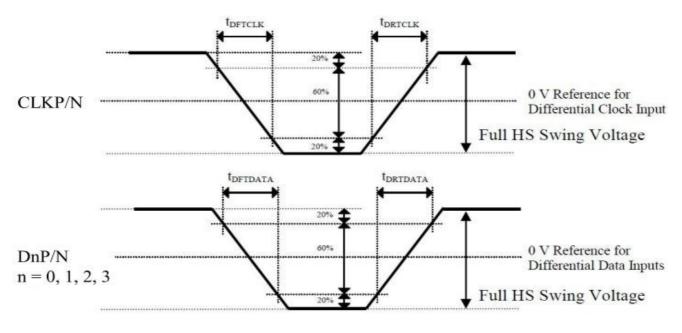


DSI Data to Clock Channel Timings

DSI Data to Clock Channel Timings

Signal	Symbol	Parameter	Min	Max
DnP/N , n=0 and 1	t _{os}	Data to Clock Setup time	0.15xUI	-
	t _{он}	Clock to Data Hold Time	0.15xU	-

6.1.3 High Speed Mode-Rising and Falling Timings



Rising and Falling Timings on Clock and Data Channels



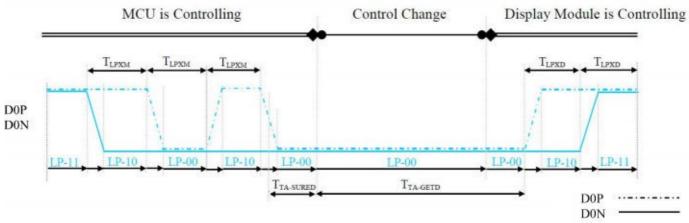
Rising and Falling Timings on Clock and Data Channels

Descentes	Cumbal	Condition	Specification		
Parameter	Symbo	Condition	Min	Тур	Max
Differential Rise Time for Clock	t _{DRTCLK}	CLKP/N	150 ps	-	0.3UI (Note)
Differential Rise Time for Data	t _{drtdata}	DnP/N n=0 and 1	150 ps	-	0.3UI (Note)
Differential Fall Time for Clock	t _{DFTCLK}	CLKP/N	150 ps	-	0.3UI (Note)
Differential Fal Time for Data	t _{dftdata}	DnP/N n=0 and 1	150 ps	-	0.3UI (Note)

Note: The display module has to meet timing requirements, which are defined for the transmitter (MCU) on MIPI D-Phy standard.

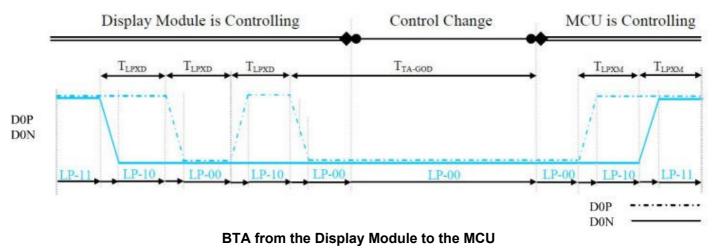
6.1.4 Low Speed Mode- Bus Turn Around

Lower Power Mode and its State Periods on the Bus Turnaround (BTA))from the MCU to the Display Module ILI9881C) are illustrated for reference purposes below.



BTA from the MCU to the Display Module

Lower Power Mode and its State Periods on the Bus Turnaround(BTA) from the Display Module (LI9881C) to the MCU are ilustrated for reference purposes below.





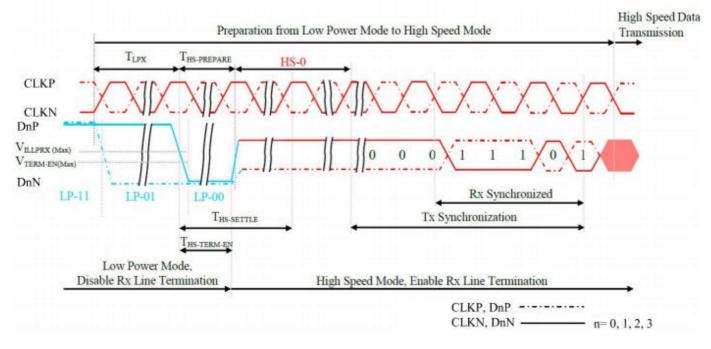
Low Power State Period Timings-A

Signa	Symbo	Description	Min	Max	Unit
D0P/N	TLPXM	Length of LP-00, LP-01, LP-10 or LP-11 periods MCU → Display Module (ILI9881C)	50	75	ns
D0P/N	T _{LPXD}	Length of LP-00, LP-01, LP-10 or LP-11 periods Display Module (ILI9881C) → MCU	50	75	ns
D0P/N	TTA-SURED	Time-out before the Display Module (ILI9881C) starts driving	TLPXD	2xT _{LPXD}	ns

Low Power State Period Timings-B

Sig	gnal	Symbol	Description	Time	Unit
D0	P/N	T _{TA-GETD}	Time to drive LP-00 by Display Module (ILI9881C)	$5xT_{LPXD}$	ns
D0	P/N	T _{TA-GOD}	Time to drive LP-00 after turnaround request - MCU	$4xT_{LPXD}$	ns

6.1.5 Data Lanes from Low Power Mode to High Speed Mode



Data Lanes-Low Power Mode to High Speed Mode Timings

Data Lanes-Low Power Mode to High Speed Mode Timings

Signal	Symbol	Description		Max	Unit
DnP/N, n = 0 and 1	TLPX	Length of any Low Power State Period	50	-	ns
DnP/N, n = 0 and 1	T _{HS-PREPARE}	Time to drive LP-00 to prepare for HS Transmission	40+4xU	85+6xU	ns
	T _{HS-TERM-EN}	Time to enable Data Lane Receiver line termination		35+4xUI	20
DnP/N, n = 0 and 1		measured from when Dn crosses VILMAX	-	35+4XU	ns

High Speed Data Transmission TEOT LP-11 CLKP CLKN Note DnP DnN THS-SKIP The last load bit T_{HS-TRAIL} T_{HS-EXIT} HS-0 or HS-1 Low Power Mode, High Speed Mode, Enable Rx Line Termination Disable Rx Line Termination Note: CLKP, DnP CLKN, DnN If the last load bit is HS-1, the transmitter changes from HS-1 to HS-0. n = 0, 1, 2, 3If the last load bit is HS-0, the transmitter changes from HS-0 to HS-1.

6.1.6 Data Lanes from High Speed Mode to Low Power Mode

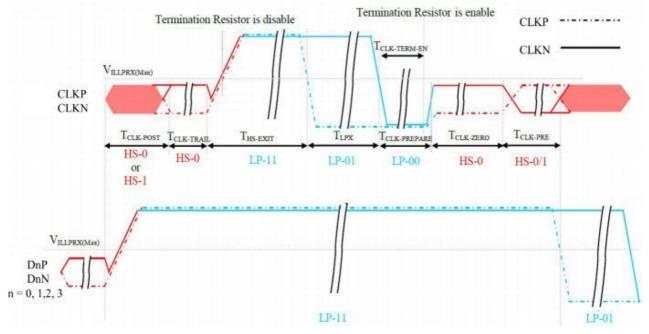
LCD

Data Lanes- High Speed Mode to Low Power Mode Timings

Data Lanes- High Speed Mode to Low Power Mode Timings

Signal	Symbol	Description	Min	Мах	Unit
DnP/N, n = 0 and 1	T _{HS-SKIP}	Time-Out at Display Module (ILI9881C) to ignore transition period of EoT	40	55+4xU	ns
DnP/N, n = 0 and 1	T _{HS-EXIT}	Time to driver LP-11 after HS burst	100	-	ns

6.1.7 DSI Clock Burst-High Speed Mode to/from Low Power Mode



Clock Lanes-High Speed Mode to/from Low Power Mode Timings



Signal	Symbol	Description	Min	Max	Unit
CLKP/N	T _{CLK-POST}	Time that the MCU shall continue sending HS clock after the last associated Data Lanes has transitioned to LP mode	60+52xUI	-	ns
CLKP/N	T _{CLK-TRAIL}	Time to drive HS differential state after last payload clock bit of a HS transmission burst	60	-	ns
CLKP/N	T _{HS-EXIT}	Time to drive LP-11 after HS burst	100	-	ns
CLKP/N	T _{CLK-PREPARE}	Time to drive LP-00 to prepare for HS transmission	38	95	ns
CLKP/N	T _{CLK-TERM-EN}	Time-out at Clock Lane to enable HS termination	-	38	ns
CLKP/N	T _{CLK-PREPARE} + T _{CLK-ZERO}	Minimum lead HS-0 drive period before starting Clock	300	-	ns
CLKP/N	T _{CLK-PRE}	Time that the HS clock shall be driven prior to any associated Data Lane beginning the transition from LP to HS mode	8xU	-	ns

Clock Lanes-High Speed Mode to/from Low Power Mode Timings



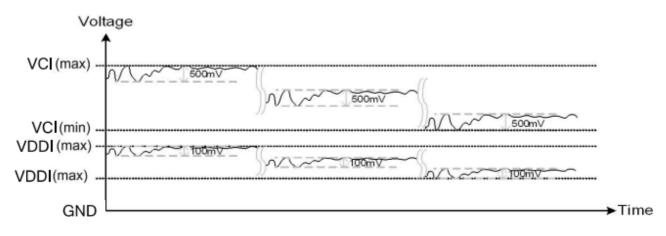
6. 2.DC Electrical Characteristics

6.2.1 DC Characteristics for Power Lines

Demonster	Complete I	Specification			on	11-14
Parameter	Symbol	Condition	Min.	Тур.	Max.	Unit
Analog power supply voltage	VCI	Operating voltage	2.5	2.8	6.0	V
Digital power supply voltage	VDD	Operating voltage	1.65	1.8	3.3	V
Analog power supply voltage	VvcLnoise	Noise Range, 0 to 100MHz, Sinusoidal Wave (peak-to-peak)	-	-	100	mV
noise		Noise Range, 0 to 30kHz, Pulse Wave with Duty Cycle (50%/50%)	-	-	500	mV
Disited source surch welters		Noise Range, 0 to 100MHz,				
Digital power supply voltage noise	VVDDI_NOISE	Sinusoidal Wave (peak-to-peak)	-	-	100	mV

Notes:

- 1. Ta =-30℃ to 70℃(to +85 ℃ no damage)
- 2. These vales are not symmetic amplitude, which center points are VDDI or VCI. See examples, when VVCI_NOISE and VVDDI_NOISE are maximums, as reference purposes below.



Noise on Power Supply Lines



6.2.2 DC Characteristics for DSI LP Mode

DC levels of the LP-00,LP-01,LP-10and LP-11 are defined in the table below: DC Characteristics for the DSI LP mode when LP-RX, LP-CD or LP-TX is mentioned in the condition column. Other logical levels in the table are for MCU interface.

Demonster	Cumbel.	Que difficer		Specification		Unit
Parameter	Symbol	Condition	Min.	Тур.	Max.	
Logic 1 input voltage	VIHLPCD	LP-CD	450	-	1350	mV
Logic 0 input voltage	VILLPCD	LP-CD	0.0	-	200	mV
Logic 1 input voltage	VIHLPRX	LP-RX (CLK, D0 ,D1, D2, D3)	880	-	1350	mV
Logic 0 input voltage	VILLPRX	LP-RX (CLK, D0 ,D1, D2, D3)	0.0	-	550	mV
Logic 0 input voltage	VILLPRXULP	LP-RX (CLK ULP mode)	0.0	-	300	mV
Logic 1 output voltage	VOHLPTX	LP-TX (D0)	1.1	-	1.3	V
Logic 0 output voltage	VOLLPTX	LP-TX (D0)	-50	-	50	mV
Logic 1 input current	I _{IH}	LP-CD, LP-RX	-	-	10	uA
Logic 0 input current	IL.	LP-CD, LP-RX	-10	-	-	uA

Notes:

1. Ta=-30 °cto 70 °c(to+85 °c no damage)

2. DSI High Speed mode is off.

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6.2.3 DC Characteristics for DSI HS mode

Parameter	Symbol	Condition	S	pecificatio	n	Unit
Input Common Mode Voltage for Clock	V _{CMCLK}	CLKP/N Note 2, Note 3	70	-	330	mV
Input Common Mode Voltage for Data	V_{CMDATA}	DnP/N Note 2, Note 3, Note 5	70	-	330	mV
Common Mode Ripple for Clock Equal or Less than 450MHz	V _{CMRCLKL450}	CLKP/N Note 4	-50	-	50	mV
Common Mode Ripple for Data Equal or Less than 450MHz	V _{CMRDATAL450}	DnP/N Note 4, Note 5	-50	-	50	mV
Common Mode Ripple for Clock More than 450MHz (peak sine wave)	V _{CMRCLKM450}	CLKP/N	-	-	100	mV
Common Mode Ripple for Data More than 450MHz (peak sine wave)	V _{CMRDATAM450}	DnP/N Note 5	-	-	100	mV
Differential Input Low Level Threshold Voltage for Clock	V _{THLCLK} -	CLKP/N	-70	-	-	mV
Differential Input Low Level Threshold Voltage for Data	V _{THLDATA} -	DnP/N Note 5	-70	-	-	mV
Differential Input High Level Threshold Voltage for Clock	V _{THHCLK*}	CLKP/N	-	-	70	mV
Differential Input High Level Threshold Voltage for Data	$V_{\text{THHDATA}*}$	DnP/N Note 5	-	-	70	mV
Single-ended Input Low Voltage	VILHS	CLKP/N, DnP/N Note 3, Note 5	-40	-	-	mV
Single-ended Input High Voltage	VIHHS	CLKP/N, DnP/N Note 3, Note 5	-	-	460	mV
Differential Termination Resistor	R _{TERM}	CLKP/N, DnP/N Note 5	80	100	125	Ω
Single-ended Threshold Voltage for Termination Enable	V _{term-en}	CLKP/N, DnP/N Note 5	-	-	450	mV
Termination Capacitor	C _{TERM}	CLKP/N, DnP/N Note 5, Note 6	-	-	60	pF

Notes:

1. Ta=-30 $^\circ\mathrm{C}$ to 70 $^\circ\mathrm{C}$ (to+85 $^\circ\mathrm{C}$ no damage),VCI=2.5V to 6.0V,VDDI=1.65V to 3.3V

2. Includes 50mV (-50mV to 50mV) ground difference

3. Without VCMRCLKM450/VCMRDATAM450

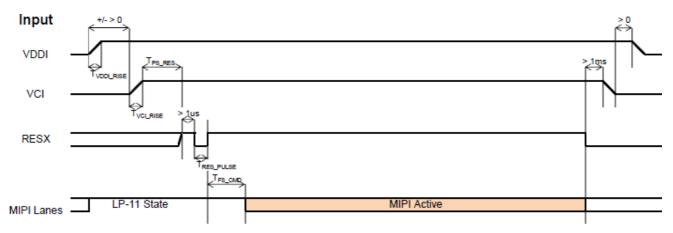
4. Without 50mV (-50mV to 50mV) ground diference

5. n = 0 and 1

6. For higher bit rates, a 14pF capacitor will be needed to meet the common-mode return loss specification.

6. 3. Power ON/OFF Sequence

Power Mode 3



Symbol	Characteristics		Тур.	Max.	Units
T _{VDDI_RISE}	VDDI Rise time		-	-	us
T _{VCI_RISE}	VCI Rise time	200	-	-	us
T _{PS_RES}	VDDI/VCI on to Reset high	5	-	-	ms
T _{RES_PULSE}	Reset low pulse time	10	-	-	us
T _{FS_CMD}	Reset to first command	10	-	-	ms

Power on/off sequence with Power Mode 3



7. Optical Characteristics

ltem		Symbol	Condition	Min	Тур	Мах	Unit	Remark
		θТ		-	80	-		
View Angl	00	θΒ	CR≥10	-	80	-	Dograa	Note 2
view Aligi	65	θL		-	80	-	Degree	Note 2
		θR		-	80	-		
Contrast Ra	atio	CR	$\theta = 0^{\circ}$	900	1200	-		Note 1 Note 3
Response T	ïme	$T_{ON+}T_{OFF}$	25°C	-	-	35	ms	Note 1 Note 4
	W _x	х		(0.249)	(0.289)	(0.329)		
	Wy	у		(0.273)	(0.313)	(0.353)		
	Rx	х		(0.581)	(0.621)	(0.661)		
Chromaticity	Ry	у	$\theta = 0^{\circ}$	(0.322)	(0.362)	(0.402)		Note 1
Chiomaticity	Gx	х		(0.275)	(0.315)	(0.355)		Note 5
	Gy	У		(0.565)	(0.605)	(0.645)		
	Bx	х		(0.114)	(0.154)	(0.194)		
	By	у		(0.050)	(0.090)	(0.130)		
Uniformit	у	U		75	-	-	%	Note 5
Luminanc	e	L		-	300	-	cd/m ²	Note 1 Note 5

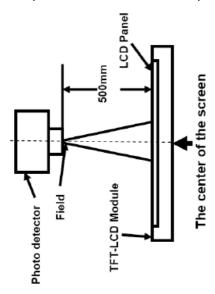
Test Conditions:

- 1. If=60mA(Backlight current), VCC _2.8V=2.8V, the ambient temperature is 25°C.
- 2. The test systems refer to Note 2.



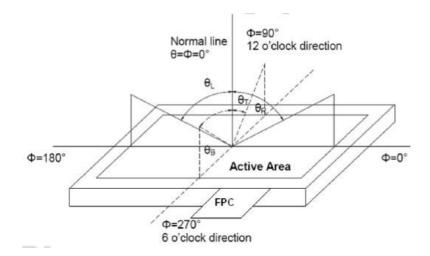
Note1: Definition of optical measurement system.

The optical characteristics should be measured in dark room. After 5Minutes operation, the optical properties are measured at the center point of the LCD screen. ALL input terminals LCD panel must be ground when measuring the center area of the panel.



Item	Photo detector	Field	
Contrast Ratio			
Luminance	CS1000	1°	
Lum Uniformity			
Chromaticity	CS1000		
Response Time	DMS703	-	

Note2: Definition of viewing angle range and measurement system. Viewing angle is measured at the center point of the LCD by CONOSCOPE (DMS703)



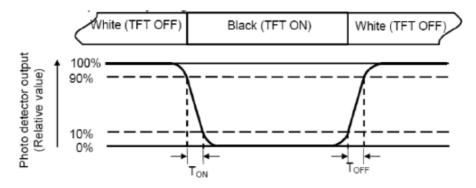
Note3: Definition of contrast ratio

White state ":The state is that the LCD should drive by Vwhite.

 $Contrast ratio(CR) = \frac{Luminance measured when LCD is on the "White" state}{Luminance measured when LCD is on the "Black" state "Black state ":The state is that the LCD should drive by Vblack. Vwhite: To be determined Vblack: To be determined$

Note4: Definition of Response time

The response time is defined as the LCD optical switching time interval between "White"state and "Black" state. Rise time (T_{ON}) is the time between photo detector output intensity changed from 90% to 10%. And fall time (T_{OFF}) is the time between photo detector output intensity changed from 90% to 10%.



Note5: Definition of color chromaticity (CIE1931)

Color coordinates measured at center point of LCD.

Color coordinates are subject to actual measurement.

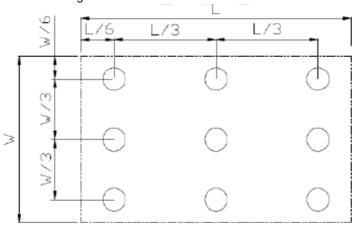
If the data has a bracket, that means reference value of TFT panel or one sample of module, the values of module TBD.

Note6: Definition of Luminance Uniformity

Active area is divided into 9 measuring areas(Refer Fig.2). Every measuring point is placed at the center of each measuring area.

Luminance Uniformity (U)=Lmin/Lmax

L-Active area length W-Active area width



L max: The measured Maximum luminance of all measurement position. L min: The measured Minimum luminance of all measurement position.

Note7: Definition of luminance: Measure the luminance of white state at center point.

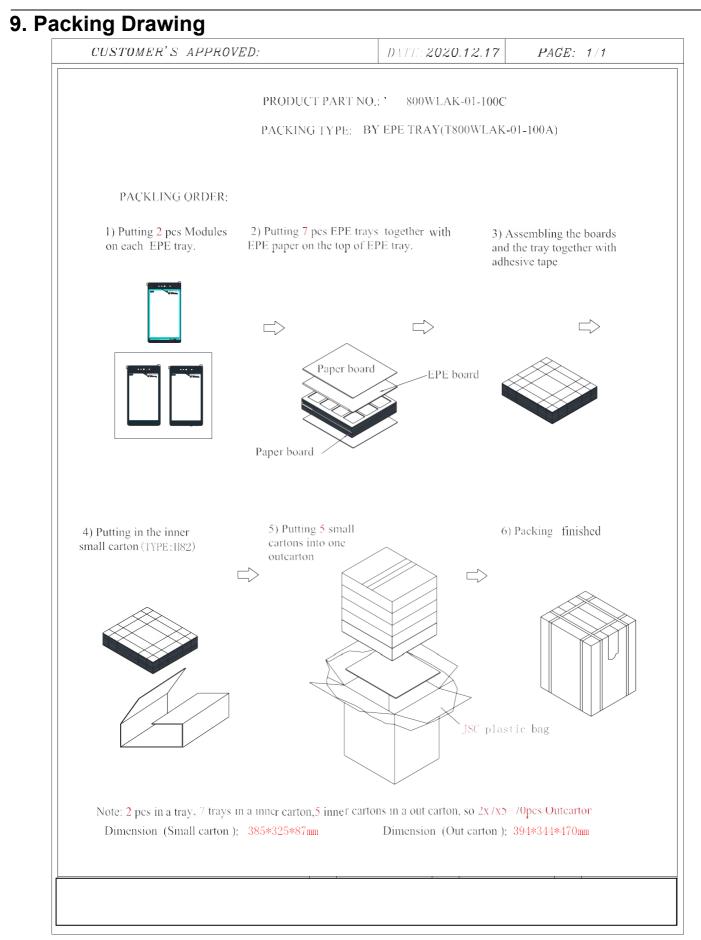
8. Environmental/Reliability Test

No.	Test Item	Test Condition	Inspection after test
1	High Temperature Storage	60±2∘c/240 hours	
2	Low Temperature Storage	-20±2∘c/240 hours	
3	High Temperature Operating	50±2∘c/240 hours	
4	Low Temperature Operating	-10±2∘c/240 hours	
5	Temperature Cycle	-20∘c~ 25∘c~ 60∘c × 10cycles (30min.) (5min.) (30min.)	Inspection after 2~4hours storage at room temperature, the sample
6	Damp Proof Test	40℃±5℃×90%RH/240 hours	shall be free from defects: 1.Air bubble in the LCD;
7	Vibration Test	Frequency: 10Hz~55Hz~10Hz Amplitude: 1.5mm, X, Y, Z direction for total 3hours (Packing condition)	2.Sealleak; 3.Non-display; 4.Missing segments; 5.Glass crack; 6.Current Idd is twice
8	Dropping test	Drop to the ground from 1m height, one time,every side of carton. (Packing condition)	higher than initial value.
9	ESD test	Voltage:±8KV R: 330Ω C: 150pF Air discharge, 10time Voltage:±6KV R: 330Ω C: 150pF Contact discharge, 10time	

Remark:

- 1. The test samples should be applied to only one test item.
- 2. Sample size for each test item is 5~10pcs.
- 3. For Damp Proof Test, Pure water(Resistance>10M Ω) should be used.
- 4. In case of malfunction defect caused by ESD damage, if it would be recovered to normal state after resetting, it would be judge as a good part.
- 5. Failure Judgment Criterion: Basic Specification, Electrical Characteristic, Mechanical Characteristic, Optical Characteristic.
- 6. Please use automatic switch menu(or roll menu) testing mode when test operatingmode.





10. Standard Specifications For Product Quality

10.1. Manner of test:

- 10.1.1 The test must be under 40W fluorescent light, and the distance of view must be at 35±5cm
- 10.1.2 Room temperature 25±5°C Humidity: (65±5)%RH.
- 10.1.3 If the product is uneven and bright spot, use 2%ND filter to check and confirm. Not visible, OK.
- 10.1.4 Inspection Angle: The vision of inspector should be perpendicular to the surface of the Module.
- 10.1.5 Inspection time: Perceptibility Test Time: 20 seconds max.

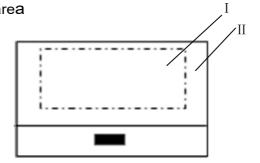
10.2. Quality specification

It shall be based on GB2828, inspection level II.

	IETM	CHECK LEVEL	AQL
MAJOR (MA)	 1.Liquid crystal leakage 2.Wrong polarizer 3.Outside dimension 4. Bright dot,Dark dot 5. Display abnormal 6. Glass crack 	п	0.65
MINOR (MI)	 Spot Defect (Including black spot,white spot,pinhole,foreign particle,bubbles,hurt) fragment Line Defect (Including black line,white line,scratch) Incision defect Newton's ring Other visual defects 	п	1.0

10.3 Definition of area

10.3.1 **T** area: viewing area II area: outside viewing area



10.4. Standard of appearance test for - area: (unit: mm)

NOTE: Defect ignore for II area.

10.4.1 Bright/Dark Dots explain

Name	Explain	Definition		
Bright dot	Dots appear bright and unchanged in size in which LCD panel is displaying under black pattern	The definition of dot: The size of a defective dot over 1/2 of single pixel dot is		
Dark dot	Dots appear dark and unchanged in size in which LCD panel is displaying under pure red, green, blue pattern.	regarded as one defective dot . Note:One pixel consists of 3 sub-pixels, including R,G, and B dot.(Sub-pixel = Dot)		
Adjacent Dot	Adjacent two sub-pixel are defect (define two dot defect)			

10.4.2 Inspection standard

No	Items		Crite	rion		Checking manner	Defect classes
		LCD≤4.3"	4.3" <lcd<7"< td=""><td>7"≤LCD≤12"</td><td>LCD>12"</td><td></td><td>MAJ</td></lcd<7"<>	7"≤LCD≤12"	LCD>12"		MAJ
		Bright dot: N≤2 Dark dot: N≤3 Total: N≤4	Bright dot. N≤3 Dark dot. N≤4 Total. N≤6	Bright dot. N≤4 Dark dot: N≤5 Total: N≤8	Bright dot: N≤5 Dark dot: N≤6 Total: N≤10	Checking	
1	Bright/dark dot	5mm The distance b more than 10 r	etween the two de etween two defec nm dot defect N≤0		•	with eyes	
	Spot defects	Note. Aujacent					
2	(black and white spot, pinhole,						MIN
	foreign matter, dent, backlight foreign matter)	D≤0.15 Ignore 0.15< D≤0.3 N≤3 0.3 <d n="0</td"><td>D≤0.2 Ignore 0.2< D≤0.5 N≤4 0.5<d n="0</td"><td>D≤0.2 Ignore 0.2< D≤0.5 N≤5 0.5<d n="0</td"><td>D≤0.2 Ignore 0.2< D≤0.5 N≤6 0.5<d n="0</td"><td>Checking with eyes</td><td></td></d></td></d></td></d></td></d>	D≤0.2 Ignore 0.2< D≤0.5 N≤4 0.5 <d n="0</td"><td>D≤0.2 Ignore 0.2< D≤0.5 N≤5 0.5<d n="0</td"><td>D≤0.2 Ignore 0.2< D≤0.5 N≤6 0.5<d n="0</td"><td>Checking with eyes</td><td></td></d></td></d></td></d>	D≤0.2 Ignore 0.2< D≤0.5 N≤5 0.5 <d n="0</td"><td>D≤0.2 Ignore 0.2< D≤0.5 N≤6 0.5<d n="0</td"><td>Checking with eyes</td><td></td></d></td></d>	D≤0.2 Ignore 0.2< D≤0.5 N≤6 0.5 <d n="0</td"><td>Checking with eyes</td><td></td></d>	Checking with eyes	
	D=(X+Y)/2 Bubble	D≤0.2	D≤0.2	D≤0.2	D≤0.2		
3	D=(X+Y)/2	Ignore 0.2< D≤0.5 N≤3 0.5 <d n="0</td"><td>Ignore 0.2< D≤0.5 N≤4 0.5<d n="0</td"><td>lgnore 0.2< D≤0.5 N≤5 0.5<d n="0</td"><td>lgnore 0.2< D≤0.5 N≤6 0.5<d n="0</td"><td></td><td></td></d></td></d></td></d></td></d>	Ignore 0.2< D≤0.5 N≤4 0.5 <d n="0</td"><td>lgnore 0.2< D≤0.5 N≤5 0.5<d n="0</td"><td>lgnore 0.2< D≤0.5 N≤6 0.5<d n="0</td"><td></td><td></td></d></td></d></td></d>	lgnore 0.2< D≤0.5 N≤5 0.5 <d n="0</td"><td>lgnore 0.2< D≤0.5 N≤6 0.5<d n="0</td"><td></td><td></td></d></td></d>	lgnore 0.2< D≤0.5 N≤6 0.5 <d n="0</td"><td></td><td></td></d>		



No	Items		Crite	erion		Checking manner	Defect classes
4	Line defects(black and white line, backlight foreign matter etc.)	LCD≤4.3" W≤0.03 Ignore 0.03< W≤0.06 L≤5 N≤3 W >0.06 L>5 N=0	4.3" <lcd< 7" W≤0.03 Ignore 0.03< W≤0.1 L≤5 N≤4 W>0.1 L> 5 N=0</lcd< 	7"≤LCD≤12" W≤0.03 Ignore 0.03< W≤0.1 L≤5 N≤5 W>0.1 L> 5 N=0	LCD>12" W≤0.03 Ignore 0.03< W≤0.1 L≤5 N≤6 W>0.1 L> 5 N=0	Checking with eyes	MIN
5	Scratch	W≤0.03 Ignore 0.03< W≤0.2 1.0 <l≤ 5.0<br="">N≤3 W >0.2 L>5 N=0</l≤>	W≤0.03 Ignore 0.03< W≤0.2 1.0 <l≤ 5.0<br="">N≤4 W >0.2 L>5 N=0</l≤>	W≤0.03 Ignore 0.03< W≤0.2 1.0 <l≤ 5.0<br="">N≤5 W >0.2 L>5 N=0</l≤>	W≤0.03 Ignore 0.03< W≤0.2 1.0 <l≤ 5.0<br="">N≤6 W >0.2 L>5 N=0</l≤>	Checking with eyes	MIN
6	Display abnormal	Not allowed				Checking with eyes	MAJ
7	Outside dimension	Accord with dra	Accord with drawing			Calipers	MAJ
8	Glass crack	Not allowed			Checking with eyes	MAJ	
9	Leak	Not allowed			Checking with eyes	MAJ	
10	Comer and side fragment	崩角 * ・ ・	崩边 X Y Y Y	 Comer frage X , Y: allowed Side fragment X≤2.0mm allowed 	≤1mm Z≤T/2	Calipers& Eyes	MIN
11	Crack	NG		Eyes	MAJ		
12	Newton's ring (CTP or Cover board)		,	Newton's ring<1 lightened ,no infl words and lines		Checking with eyes	MIN



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TP	标准
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No	Items	Phenomenon/picture	Criterion	Checking manner	Defect class
1	Outside dimension		Accord with drawing	Calipers& Eyes	MIN
2	Color deviation	Difference of ink color	Obvious deviation compared with samples	Eyes	MIN
3	Ink pinhole	油墨针孔	No any holes near VA side 3mm Out of VA. D≤0.15mm N≤1 ,no present in reflection condition.	Eyes Film	MIN
4	Ink saw tooth	印刷锯齿	W≤0.15mm N=1	Eyes Film	MIN
5	Ink light leakage	油墨漏光	1、width of light leakage at the edge area ≤0.15mm OK 2、width of light leakage at the edge area >0.15mm NG	Eyes Film	MIN
6	Cover glass profile		No ink, adhesive, oil stain, etc.	Eyes	MIN
7	IR(LED)dot/black- white dot	CN	φ≤0.2 、 N≤1 0.15 ∢φ、not allowed	Eyes& Film	MIN
8	IR(LED)dot black- white dot/different color		no present when use all viewing angle to determine at 35cm ,allowed	Eyes	MIN
9	Shooting hole	CANE X	φ≤0.2 、 N≤1 0.15 ∢φ、not allowed	Eyes& Film	MIN



LCD MODULE LCD800WLAK-01-100C

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10	LOGO/ICON black-white dot	₽	Diagram clear φ≤0.2、N≤1	Eyes& Film	MIN
11	FPC warped	FPC翘曲	ОК	Eyes	MIN
12	FPC broken, stained, oxidation	FPC折伤	NG	Eyes	MAJ
13	Stain		No evident finger print, oil print, gelatinoids, etc.	Eyes	MIN
14	Sponge		Presented in AA area. NG	Eyes	MIN
15	Protection foil	Finished Protection foil	 Protection foil stain: In normal inspection condition ,finger print. pen print and gelatinoids are presented. NG Bubble≤5.0mm ,or according to client's limited sample Protection foil worn and warped. NG Scratch: W≤0.10mm. ignore length; 0.10mm< W≤0.20mm, L≤30mm, and N≤4,d>15mm; OK;L>30mm or W>0.20mm;NG 	Eyes& Film	MIN

11. Precautions for Use of LCD Modules

11.1 Handing Precautions

- (1) The display panel is made of glass and polarizer. As glass is fragile. It tends to become or chipped during handling especially on the edges. Please avoid dropping or jarring. Do not subject it to a mechanical shock by dropping it or impact.
- (2) If the display panel is damaged and the liquid crystal substance leaks out, be sure not to get any in your mouth. If the substance contacts your skin or clothes, wash it off using soap and water.
- (3) Do not apply excessive force to the display surface or the adjoining areas since this may cause the color tone to vary. Do not touch the display with bare hands. This will stain the display area and degraded insulation between terminals (some cosmetics are determined to the polarizer).
- (4) The polarizer covering the display surface of the LCD module is soft and easily scratched. Handle this polarizer carefully. Do not touch, push or rub the exposed polarizer with anything harder than an HB pencil lead (glass, tweezers, etc.). Do not put or attach anything on the display area to avoid leaving marks on. Condensation on the surface and contact with terminals due to cold will damage, stain or dirty the polarizer. After products are tested at low temperature they must be warmed up in a container before coming is contacting with room temperature air.
- (5) If the display surface becomes contaminated, breathe on the surface and gently wipe it with a soft dry cloth. If it is heavily contaminated, moisten cloth with one of the following solvents
 - Isopropyl alcohol
 - Ethyl alcohol
 - Do not scrub hard to avoid damaging the display surface.
- (6) Solvents other than those above-mentioned may damage the polarizer. Especially, do not use the following.
 - Water
 - Ketone
 - Aromatic solvents

Wipe off saliva or water drops immediately, contact with water over a long period of time may cause deformation or color fading. Avoid contacting oil and fats.

- (7) Exercise care to minimize corrosion of the electrode. Corrosion of the electrodes is accelerated by water droplets, moisture condensation or a current flow in a high-humidity environment.
- (8) Install the LCD Module by using the mounting holes. When mounting the LCD module make sure it is free of twisting, warping and distortion. In particular, do not forcibly pull or bend the I O cable or the backlight cable.
- (9) Do not attempt to disassemble or process the LCD module.
- (10) NC terminal should be open. Do not connect anything.
- (11) If the logic circuit power is off, do not apply the input signals.
- (12) Electro-Static Discharge Control, Since this module uses a CMOS LSI, the same careful attention should be paid to electrostatic discharge as for an ordinary CMOS IC. To prevent destruction of the elements by static electricity, be careful to maintain an optimum work environment.

- Before remove LCM from its packing case or incorporating it into a set, be sure the module and your body have the same electric potential. Be sure to ground the body when handling the LCD modules.

- Tools required for assembling, such as soldering irons, must be properly grounded. make certain the AC power source for the soldering iron does not leak. When using an electric screwdriver to attach LCM, the screwdriver should be of ground potentiality to minimize as much as possible any transmission of electromagnetic waves produced sparks coming from the commutator of the motor.

- To reduce the amount of static electricity generated, do not conduct assembling and other work under dry conditions. To reduce the generation of static electricity be careful that the air in the work is not too dried. A relative humidity of 50%-60% is recommended. As far as possible make the electric potential of your work clothes and that of the work bench the ground potential.

The LCD module is coated with a film to protect the display surface. Exercise care when peeling off this protective film since static electricity may be generated.

- (13) Since LCM has been assembled and adjusted with a high degree of precision, avoid applying excessive shocks to the module or making any alterations or modifications to it.
 - Do not alter, modify or change the shape of the tab on the metal frame.
 - Do not make extra holes on the printed circuit board, modify its shape or change the positions of components to be attached.
 - Do not damage or modify the pattern writing on the printed circuit board.
 - Absolutely do not modify the zebra rubber strip (conductive rubber) or heat seal connector.
 - Except for soldering the interface, do not make any alterations or modifications with a soldering iron.
 - Do not drop, bend or twist LCM.

11.2Storage Precautions

When storing the LCD modules, the following precaution is necessary.

- (1) Store them in a sealed polyethylene bag. If properly sealed, there is no need for the dessicant.
- (2) Store them in a dark place. Do not expose to sunlight or fluorescent light, keep the temperature between 0℃ and 35℃.
- (3) The polarizer surface should not come in contact with any other objects. (We advise you to store them in the container in which they were shipped).

11.3 Others

- (1) Liquid crystals solidify under low temperature (below the storage temperature range) leading to defective orientation or the generation of air bubbles (black or white). Air bubbles may also be generated if the module is subject to a low temperature.
- (2) If the LCD modules have been operating for a long time showing the same display patterns, the display patterns may remain on the screen as ghost images and a slight contrast irregularity may also appear. A normal operating status can be regained by suspending use for some time. It should be noted that this phenomenon does not adversely affect performance reliability.
- (3) To minimize the performance degradation of the LCD modules resulting from destruction caused by static electricity etc., exercise care to avoid holding the following sections when handling the modules.
 - Exposed area of the printed circuit board.
 - -Terminal electrode sections.

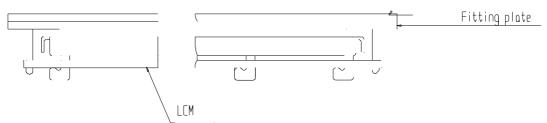
11.4 USING LCD MODULES

Installing LCD Modules

The hole in the printed circuit board is used to fix LCM as shown in the picture below. Attend to the following items when installing the LCM.

(1) Cover the surface with a transparent protective plate to protect the polarizer and LC cell.

Protective plate

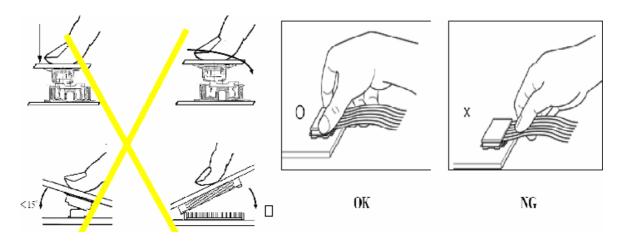


(2) When assembling the LCM into other equipment, the spacer to the bit between the LCM and the fitting plate should have enough height to avoid causing stress to the module surface, refer to the individual specifications for

measurements. The measurement tolerance should be 0.1mm.

Precaution for assemble the module with BTB connector:

Please note the position of the male and female connector position, don't assemble or assemble like the method which the following picture shows



Precaution for soldering to the LCM

	Hand soldering	Machine drag soldering	Machine press soldering
No ROHS Product	290_C~350_C. Time :3-5S.	330_C ~350_C. Speed : 4- 8mm/s.	300_C~330C. Time : 3-6S. Press: 0.8~1.2Mpa
ROHS Product	340_C~370_C. Time:3-5S.	350_C ~370_C. Time : 4-8 mm/s.	330_C~360C. Time : 3-6S. Press: 0.8~1.2Mpa

- (1) If soldering flux is used, be sure to remove any remaining flux after finishing to soldering operation. (This does not apply in the case of a non-halogen type of flux.) It is recommended that you protect the LCD surface with a cover during soldering to prevent any damage due to flux spatters.
- (2) When soldering the electroluminescent panel and PC board, the panel and board should not be detached more than three times. This maximum number is determined by the temperature and time conditions mentioned above, though there may be some variance depending on the temperature of the soldering iron.
- (3) When remove the electroluminescent panel from the PC board, be sure the solder has completely melted, the soldered pad on the PC board could be damaged.

Precautions for Operation

- (1) It is an indispensable condition to drive LCD's within the specified voltage limit since the higher voltage then the limit cause the shorter LCD life. An electrochemical reaction due to direct current causes LCD's undesirable deterioration, so that the use of direct current drive should be avoided.
- (2) Response time will be extremely delayed at lower temperature than the operating temperature range and on the other hand at higher temperature LCD's show dark color in them. However those phenomena do not mean malfunction or out of order with LCD's, which will come back in the specified operating temperature.
- (3) If the display area is pushed hard during operation, the display will become abnormal. However, it will return to normal if it is turned off and then back on.
- (4) A slight dew depositing on terminals is a cause for electro-chemical reaction resulting in terminal open circuit. Usage under the maximum operating temperature,50%RH or less is required.
- (5) Input each signal after the positive/negative voltage becomes stable.
- (6) Please keep the temperature within specified range for use and storage. Polarization degradation, bubble generation or polarizer peel-off may occur with high temperature and high humidity.



Safety

- (1) It is recommended to crush damaged or unnecessary LCDs into pieces and wash them off with solvents such as acetone and ethanol, which should later be burned.
- (2) If any liquid leaks out of a damaged glass cell and comes in contact with the hands, wash off thoroughly with soap and water.

11.5The disposal of waste

For waste disposal, our recommendations are as follows, please refer to your company, and the relevant provisions of the state laws and regulations of the act accordingly

- 1. Packing materials disposal for our packaging (carton/PS tray/EPE tray/PET tray)
- 1) Our company used to recycle and reuse materials, packing materials can be you just need to transfer to material recycling companies
- 2. Our scrap module can't be recycled for reuse, so please dispose of:
- Our scrap module can't be recycled for reuse, products and components are "served" can lead to accidents
 Our scrap can be transfer to material recycling companies, dismantling, to ensure that scrap in relatively advanced
- technology products, environmental protection measures of relatively perfect environment for processing.
- 3. WEEE order must be executed in product scrap.

12. Prior Consult Matter

- 1. (1) For standard products, we keep the right to change material, process **. f**or improving the product property without notice on our customer.
 - (2) For OEM products, if any change needed which may affect the product property, we will consult with our customer in advance.
- 2. If you have special requirement about reliability condition, please let us know before you start the test on our samples.

13. Factory

FACTORY NAME: LCD Mikroelektronik GmbH FACTORY ADDRESS: Otto-Lilienthal-Str. 13, D-76275 Ettlingen